## 3.2x2.4mm SMD CHIP LED LAMP

KPD-3224SGC

SUPER BRIGHT GREEN

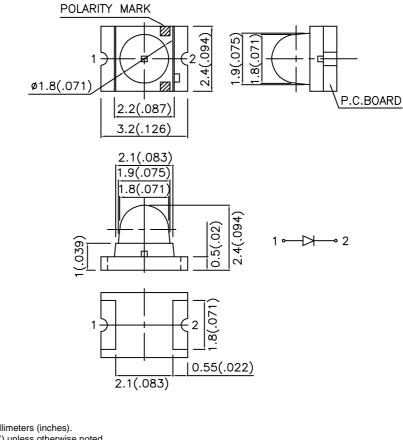
#### Features

- •3.2x2.4mm SMT LED, 2.4mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE : 1500PCS / REEL.

#### Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

### Package Dimensions



#### Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.

3. Specifications are subject to change without notice.

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Selection Guide									
Part No.	Dice	Lens Type	lv (mcd) @ 20mA		Viewing Angle				
			Min.	Тур.	201/2				
KPD-3224SGC	SUPER BRIGHT GREEN (GaP)	WATER CLEAR	18	70	20°				

Note:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

## Electrical / Optical Characteristics at TA=25°C

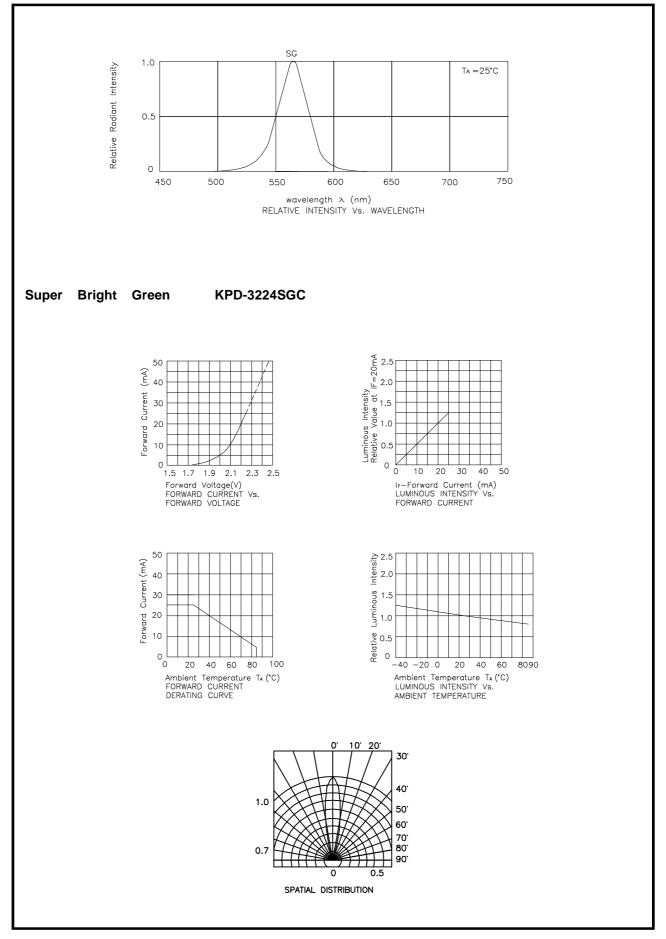
Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	IF=20mA
λD	Dominant Wavelength	Super Bright Green	568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	IF=20mA
С	Capacitance	Super Bright Green	15		pF	VF=0V;f=1MHz
Vf	Forward Voltage	Super Bright Green	2.2	2.5	V	IF=20mA
IR	Reverse Current	Super Bright Green		10	uA	VR = 5V

### Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Green	Units	
Power dissipation	105	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

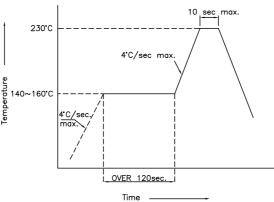


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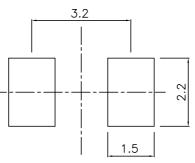
### KPD-3224SGC

#### **SMT Reflow Soldering Instructions**

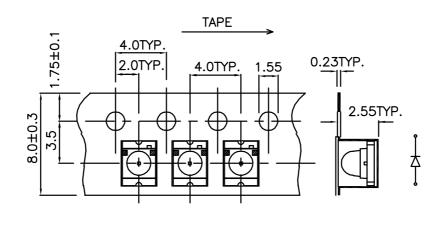
Number of reflow process shall be 2 times or less and cooling process to normal temperature is required between first and second soldering process.



# Recommended Soldering Pattern (Units : mm)



#### Tape Specifications (Units : mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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